

PATENT

SUPPLEMENTAL DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below, next to my name.

I believe that I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled Method and Apparatus for Variable Frame Size Radiolink Protocol Based on Channel Condition Estimation
the specification of which was filed on January 10, 2001 as United States Application No. 2097758,484

I hereby declare that **Figure 7**, which was referred to in the subject patent application, is part of the subject matter

_X	that is claimed and for which a application as filed,	ι patent is sought on the inv	ention in the patent
	of the claim(s) as allowed,		
	of the attached amendment(s)	,	
	of the amendment(s) filed on on the above-identified applications.		
	of the amendment(s) filed on of in Application No continuation divisional	filed	, , which is a
	of Application No.	filed	•

was part of my or our invention and was invented before the filing date of the original application, above-identified for such invention.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. Section 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. Sections 119(a)-(d) or 365(b) of any foreign applications for patent or inventor's certificate, or 365(a) of any PCT international application that designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate, or any PCT international application, having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(<u>(s)</u>		Prior <u>Clair</u>	
Number	Country	Day/Month/Year I	Filed Yes	No
Number	Country	Day/Month/Year I	Filed Yes	No
Number	Country	Day/Month/Year I	Filed Yes	No
I hereby claim the benefit listed below:	under 35 U.S.C. Se	ction 119(e) of any United S	tates provisional	applications
Application Number	Filing	Date		
Application Number	Filing Date			
PCT international applica subject matter of each of international application in acknowledge the duty to	tion designating the the claims of this appoint the manner provided disclose all information became availab	ction 120 of any United State United States of America, lis plication is not disclosed in t ed by the first paragraph of 3 on known to me to be mater le between the filing date of application:	ted below and, in the prior United St 5 U.S.C. Section ial to patentability	isofar as the tates or PCT 112, I as defined in
(U.S. Parent Application or) PCT Parent No.)	Parent Filing Date	(Status patented, pending, abandoned)	Parent Patent (if applicable)	
(U.S. Parent Application or) PCT Parent No.)	Parent Filing Date	(Status patented, pending, abandoned)	Parent Patent (if applicable)	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. Section 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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